

AN - 1985-281455 [45]

A - [001] 014 04- 040 05- 06- 07& 075 09- 141 15- 18- 226 229 231 308 309
310 311 318 339 340 341 342 38- 473 477 52& 59& 623 627 678 695 721 722

AP - SU19833656161 19831027

CPY - PASH-I

DC - A97 M23 P55

DR - 1694-U 5024-U

FS - CPI;GMPI

IC - B23K35/24

IN - BENDRIKOVA I A; PASHKOVSKA L M; VOROBEI M A

KS - 0037 0042 0093 0205 0218 0231 1282 1283 1306 2020 2215 2218 2272 2280
2282 2299 2718 2743 3257 3314

MC - A05-A01E A05-F01E A06-A00E A12-W12D M23-A02

PA - (PASH-I) PASHKOVSKAYA L M

PN - SU1152750 A 19850430 DW198545 002pp

PR - SU19833656161 19831027

XA - C1985-122302

XIC - B23K-035/24

XP - N1985-209870

AB - SU1152750 Use of asbestos (I) as filler in, and addn. of polyamide resin (II) aerosil (III) and Na molybdate (IV) to the compsn. for preventing solder from spreading, improves its properties. The mixt. contains (in wt. %): (I) 20.5-24, (II) 24.2-26.2, (III) 3.5-3.9, (IV) 0.4-0.5 and epoxide resin modified with polyorgano-siloxane cpds. (V) the rest.

- A typical mixt. contains (in wt. %): (I) 24, (II) 26.2, (III) 3.5, (IV) 0.4 and (V) 45.0. Tests show that use of (I) and addn. of (II-IV) improves the quality and machinability of the soldered surfaces, and reduces the consumption of solder and flux.

- ADVANTAGE - Improved quality of soldered surfaces, reduced emission of smoke. Bul.16/30.4.85. (2pp Dwg.No.0/0)

IW - COMPOSITION PREVENT SOLDER SPREAD CONTAIN ASBESTOS FILL MODIFIED POLYEPOXIDE RESIN ADD AEROSIL SODIUM MOLYBDATE POLYAMIDE RESIN

IKW - COMPOSITION PREVENT SOLDER SPREAD CONTAIN ASBESTOS FILL MODIFIED POLYEPOXIDE RESIN ADD AEROSIL SODIUM MOLYBDATE POLYAMIDE RESIN

INW - BENDRIKOVA I A; PASHKOVSKA L M; VOROBEI M A

NC - 001

OPD - 1983-10-27

ORD - 1985-04-30

PAW - (PASH-I) PASHKOVSKAYA L M

TI - Compsn. for preventing solder from spreading - contains asbestos as filler, modified epoxide] resin, and additional aerosil, sodium molybdate and polyamide resin